

### **Features**

- ESD Protected up to 1.5KV (HBM)
- Extremely Low Threshold Voltage
- Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# **Maximum Ratings**

- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 500°C/W Junction to Ambient<sup>(2)</sup>

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	50	V
Gate-Source Volltage	V <sub>GS</sub>	±20	V
Continuous Drain Current	I <sub>D</sub>	0.25	Α
Pulsed Drain Current <sup>(3)</sup>	I <sub>DM</sub>	2	A
Total Power Dissipation	P <sub>D</sub>	0.25	W

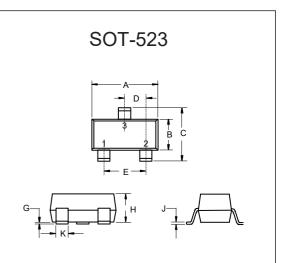
Note:

- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. Surface Mounted on 1 in<sup>2</sup> pad area, t  $\leq$  10 sec.
- 3. Pulse width  $\leq$  300µs, duty cycle  $\leq$  2%.

# Internal Structure and Marking Code

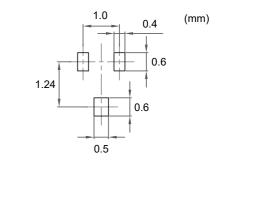


# N-CHANNEL MOSFET



	DIMENSIONS				
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	NOTE
Α	0.059	0.067	1.50	1.70	
В	0.030	0.033	0.75	0.85	
С	0.057	0.069	1.45	1.75	
D	0.020		0.50		TYP.
E	0.035	0.043	0.90	1.10	
G	0.000	0.004	0.00	0.10	
Н	0.024	0.031	0.60	0.80	
J	0.004	0.008	0.10	0.20	
K	0.006	0.014	0.15	0.35	

#### Suggested Solder Pad Layout



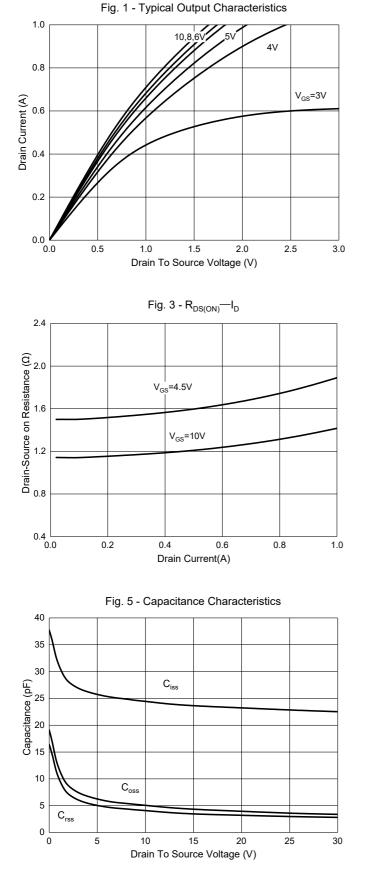


# Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static Characteristics			L	I	1	1
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250µA	50			V
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±10	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =50V, V <sub>GS</sub> =0V			1	μA
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	0.5		1.5	V
Drain-Source On-Resistance		V <sub>GS</sub> =10V, I <sub>D</sub> =0.5A			1.6	Ω
Diam-Source On-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =0.2A			2.5	Ω
Diode Characteristics						
Continuous Body Diode Current	I <sub>S</sub>				0.25	A
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =0.2A			1.3	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>s</sub> =0.5A,di/dt=100A/µs		42		ns
Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>S</sub> =0.3A,α//αι=100A/μS		41		nC
Dynamic Characteristics						
Input Capacitance	C <sub>iss</sub>			22.8		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V,f=1MHz		3.5		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			2.9		
Total Gate Charge	Qg			0.7		
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =10V, $V_{GS}$ =4.5V, $I_{D}$ =0.5A		0.3		nC
Gate-Drain Charge	Q <sub>gd</sub>			0.1		
Turn-On Delay Time	t <sub>d(on)</sub>			3.8		
Turn-On Rise Time	t <sub>r</sub>	V <sub>DS</sub> =30V, V <sub>GEN</sub> =10V, R <sub>G</sub> =25Ω, R <sub>L</sub> =60Ω,		3.4		- ns
Turn-Off Delay Time	t <sub>d(off)</sub>	R <sub>G</sub> -250, R <sub>L</sub> -6002, I <sub>DS</sub> =0.5A		19		
Turn-Off Fall Time	t <sub>f</sub>			12		



# **Curve Characteristics**



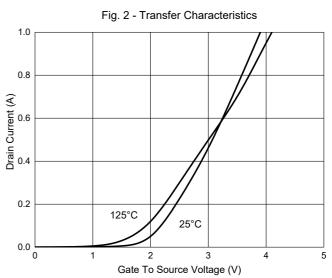
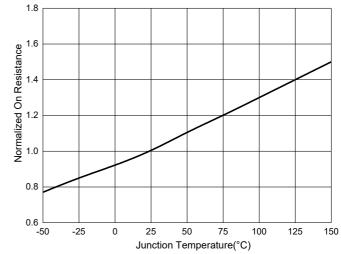
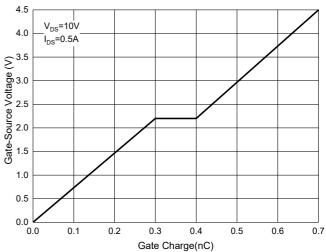


Fig. 4 - Normalized On Resistance Characteristics

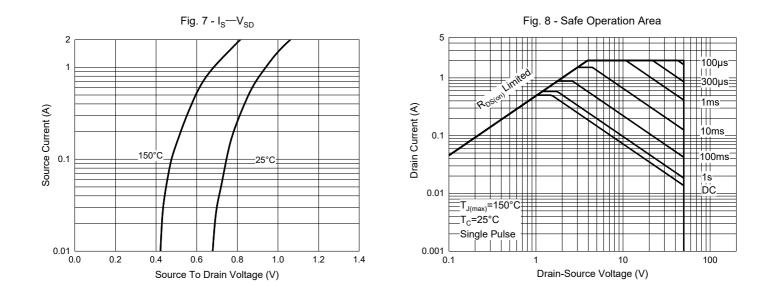








# **Curve Characteristics**





# **Ordering Information**

Device	Packing	
Part Number-TP	Tape&Reel: 3Kpcs/Reel	

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